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Class	Subclass

ISSUE CLASSIFICATION

PATENT NUMBER

U.S. UTILITY Patent Application

M/L **RW** O.I.P.E. PATENT DATE
SCANNED **115³** Q.A. **Am** **AA**

APPLICATION NO. 09/766814	CONT/PRIOR D	CLASS 257	SUBCLASS 29	ART UNIT 2814	EXAMINER C. R. J.
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Microelectronic packages having deformed bonded leads and methods therefor

PTO-2040
12/89

ISSUING CLASSIFICATION

[illegible]

<input type="checkbox"/> TERMINAL DISCLAIMER	DRAWINGS		CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed. <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent. No. _____ _____ _____	_____ (Assistant Examiner) _____ (Date)		NOTICE OF ALLOWANCE MAILED	
	_____ (Primary Examiner) _____ (Date)		ISSUE FEE	
	_____ (Legal Instruments Examiner) _____ (Date)		Amount Due	Date Paid
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	_____ (Legal Instruments Examiner) _____ (Date)		ISSUE BATCH NUMBER	

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